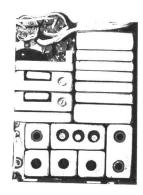
150.8-174 MHz RECEIVER ER-59-C FOR PE MODELS AND Porta•Mobile∏™



SPECIFICATIONS *

Type Number

Audio Output (EIA)

Channel Spacing

Sensitivity 12-dB SINAD (E

12-dB SINAD (EIA Method) 20-dB Quieting Method

Selectivity
EIA Two-Signal
20-dB Quieting Method

Spurious Response

Intermodulation (EIA)

Audio Response

Modulation Acceptance

Squelch Sensitivity Critical Squelch Maximum Squelch

Maximum Frequency Spacing

ER-59-C

500 milliwatts at less than 5% distortion

30 kHz

0.35 μV 0.50 μV

-85 dB at ± 30 kHz -110 dB at ± 30 kHz

-80 dB

-75 dB

+2 and -10 dB of a standard 6-dB per octave de-emphasis curve from 300 to 3000 Hz (1000-Hz reference)

 ± 7.5 kHz

 $0.25~\mu\text{V}$ Greater than 20-dB Quieting

0.60 MHz with no degradation in Rec. Sensitivity

1.20 MHz with 1 dB degradation in Rec. Sensitivity.

*These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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- WARNING -

No one should be permitted to handle any portion of the equipment that is supplied with high voltage; or to connect any external apparatus to the units while the units are supplied with power. KEEP AWAY FROM LIVE CIRCUITS!

DESCRIPTION

Receiver Models 4ER59C11 and 4ER59C13 are single conversion, superheterodyne FM receivers for operation on the 150.8-174 MHz bands. The complete receiver mounts on a single printed wiring board, and utilizes both discrete components and Integrated Circuit modules. The application of each model receiver is shown in the following chart:

Model No.	Freq. Range	Number of Freq.	Tone Option
4ER59C11	150.8-174 MHz	1 or 2	
4ER59C13	150.8-174 MHz	1 or 2	Channel Guard

References to symbol numbers mentioned in the following text are found on the Schematic Diagram, Outline Diagram and Parts List (see Table of Contents). The typical circuit diagrams used in the text are representative of the circuits used in the Integrated Circuit modules. A block diagram of the receiver is shown in Figure 1.

Supply voltage for the receiver includes a continuous regulated 5.4 Volts for the compensator module, a continuous 7.5 Volts for the squelch module, and a switched 7.5 Volts for the remaining receiver stages.

CIRCUIT ANALYSIS

OSCILLATOR MODULE

Oscillator Module 4EG28All consists of a crystal-controlled Colpitts oscillator similar to the Oscillator module used in the transmitter (see Figure 2). The entire oscillator is contained in a metal can with the receiver operating frequency printed on the top. The crystal frequency ranges from 14.53 to 17.11 MHz, and the crystal frequency is multiplied 9 times.

The oscillator frequency is temperature compensated to provide instant frequency compensation, with a frequency stability of $\pm .0002\%$ from 0°C to +55°C and $\pm .0005\%$ from -30°C to +60°C. The temperature compensation network is contained in Compensator Module A313.

In single frequency receivers, a jumper from H10 to H11 on System Board A701 connects the oscillator module to the continuous 5.4 Volt supply voltage. The oscillator output is applied to Compensator A313.

In two-frequency receivers, an additional oscillator module is mounted on the receiver board. The single-frequency supply jumper is removed, and the proper frequency

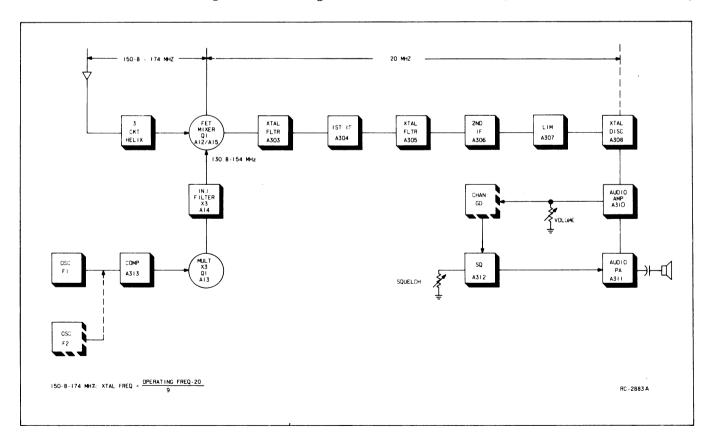


Figure 1 - Receiver Block Diagram

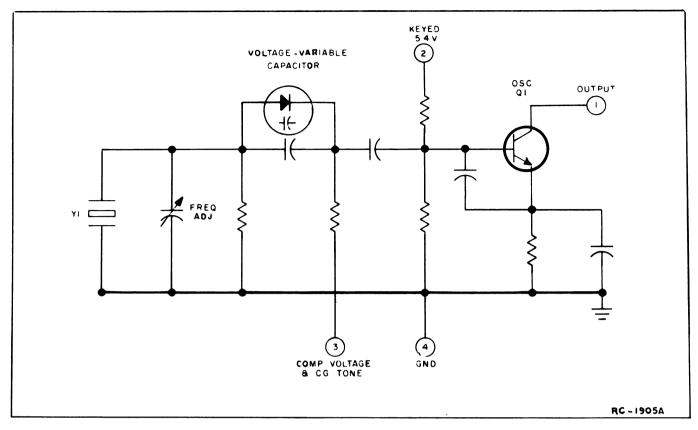


Figure 2 - Typical Oscillator Circuit

is selected by connecting the 5.4 volts to the selected oscillator module through frequency selector switch S1 on the control unit.

---- NOTE ----

All oscillator modules are individually compensated at the factory and cannot be repaired in the field. Any attempt to remove the oscillator cover will void the warranty.

COMPENSATOR A313

Compensator module A313 contains a buffer-amplifier stage, and the temperature compensation network for the oscillator similar to the Compensator used in the transmitter (see Figure 3).

RF from the oscillator is coupled through a DC blocking capacitor to the base of Ql. The output of Ql connects to multiplier coil Ll on the Multiplier assembly.

In the compensation network, the regulated 5.4 volts at Pin 2 is applied to a thermistor-compensated voltage divider. The output at Pin 3 (2.35 volts measured with a VTVM) is applied to Pin 3 and to the varactor in the Oscillator module. At temperatures below -10°C, the compensated voltage increases to maintain the proper voltage on the oscillator voltage-variable capacitor.

— SERVICE NOTE —

An abnormally low VTVM reading (or no reading) at Pin 3 may indicate a short or leakage path in the oscillator. This can be checked by unsoldering Pin 2, raising it off of the printed board and taking another reading. If this reading is normal, the problem is in the Oscillator module. If the reading remains low (or zero), the problem is in the Compensator.

FRONT END A332 (19C317295G10)

Receiver Front End Assembly 19C317295G10 consists of RF helical resonators Z28, Z29 an and Z30, and Mixer, Multiplier and injection filter circuit A16. A16 consists of Mixer-Multiplier circuit A1 and Injection Filter A1 and A3.

The crystal frequency from the receiver compensator module is applied to resonator circuit L1, C1 and C2 in Multiplier Circuit A1. Resonator circuit L1, C1 and C2 is tuned to three times the 14.53 to 17.11 MHz crystal frequency and is connected in the base circuit of multiplier transistor Q1. The collector of Q1 is connected to the input of injection filter A1-A3. Injection filter A1-A3 is tuned to nine times the crystal frequency for an injection frequency

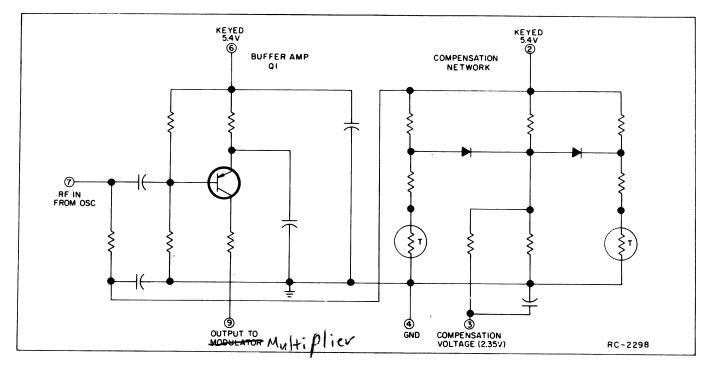


Figure 3 - Typical Compensator Circuit

of 130.8 to 154 MHz. The output of Al-A3 is connected to the source of Field Effect Transistor (FET) Q2 in mixer circuit Al.

RF from the antenna is connected to the tap on helical L27. The tap is positioned to provide proper impedance matching to the antenna. RF energy is coupled to helical coil L7 through openings in the sides of the cans. RF is coupled from a tap on L8 through capacitor C10 to L5 in mixer circuit A1. L5 is connected in the gate circuit of FET Q2. The result of the RF signal on the gate of FET Q2 and the injection frequency on the source is a 20 MHz IF on the drain. The 20 MHz IF is coupled through C12 to the input of the receiver crystal filters and coupling networks.

FRONT END A329 (Replaced by 19C317295G10)

Receiver Front End Assembly 19C317295G8 consist of RF helical resonators Z26, Z7 and Z27, Mixer circuit A12/A15 multiplier circuit A13 and injection filter circuit A14. Three times the crystal frequency from the receiver compensator module is applied to resonator circuit L1, C1 and C2 in Multiplier module A13. Resonator circuit L1, C1 and C2 is tuned to three times the 14.53 to 17.11 MHz crystal frequency and is connected in the base of multiplier transistor Q1. The collector of Q1 is connected to the input of injection A14. Injection filter A14 is tuned to nine times the crystal frequency for an injection

frequency of 130.8 to 154 MHz. The output of A14 is connected to the source of Field Effect Transistor (FET) Q1 in mixer module A12/A15.

RF from the antenna is connected to a tap on helical L26. The tap is positioned to provide proper impedance matching to the antenna. RF energy is coupled to helical coil L8 through openings in the sides of the cans. RF is coupled from a tap on L8 through capacitor C8 to L1 in mixer module A12/A15. L1 is connected in the gate circuit of FET Q1. The result of the RF signal on the gate of FET Q1 and the injection frequency on the source is a 20 MHz IF on the drain. The 20 MHz IF is coupled through matching network C4 and C5 to the input of the receiver crystal filters and coupling networks.

CRYSTAL FILTERS A318 & A319

Filter A318 follows the receiver front end and its output is applied to the 1st IF amplifier module. Filter A319 follows the IF Amplifier module. The two Crystal Filters provide the major selectivity for the receiver. A318 & A319 provides a minimum of 85-dB stop-band attenuation.

IF AMPS A304 & A306

An IF Amplifier module follows each of the crystal filters, and contain the resistor matching networks for the filters. A typical IF amplifier circuit is shown in Figure 4.

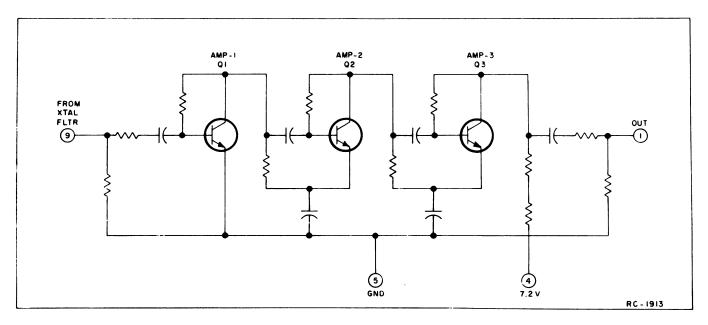


Figure 4 - Typical IF Amplifier Circuit

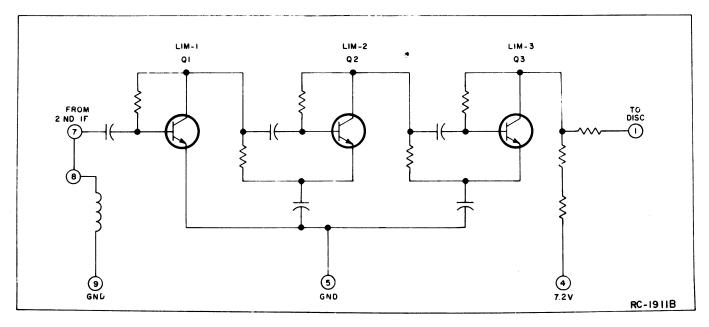


Figure 5 - Typical Limiter Circuit

Each of the IF Amplifier modules consistos of three R-C coupled amplifier stages that are DC series-connected for reduced drain. The two IF modules provide a total gain of approximately 85 dB.

LIMITER A307 & DISCRIMINATOR A308

Limiter A307 consists of three R-C coupled limiter stages that are DC series connected for reduced drain. The Limiter module also provides some gain. The out-

put of the Limiter is applied to the discriminator. A typical Limiter circuit is shown in Figure 5.

The receiver uses a 20 MHz, fixedtuned crystal discriminator (A308) to recover the audio from the IF signal. The Discriminator output is applied to the Audio Amplifier module.

AUDIO AMPLIFIER A310

Audio and noise from the discriminator is applied to Audio Amplifier module A310.

A typical audio amplifier circuit is shown in Figure 6.

Audio and noise is applied to the base of Q1. This stage operates as an emitter-follower for matching the impedance of the discriminator to the amplifier stage (Q2) and the VOLUME control. The output of Q1 connects from Pin 2 to the base of amplifier Q2 (Pin 4) through the VOLUME control. The output of Q1 is also applied to the input of the Squelch module.

Following amplifier Q2 is an active low-pass filter (Q3). Audio from the filter is connected from Pin 9 to the Audio PA module. In Audio Amplifier module A310, an active high-pass filter is added in series with the low-pass filter to provide the required tone frequency roll-off.

AUDIO PA A311

Then the receiver is quieted by a signal, audio from the active filter is connected to Pin 1 of Audio PA module A311, and then to the base of amplifier Q1. Q1 feeds the audio signal to the base of Q2, which drives PA transistors Q4 and Q5. A typical audio PA circuit is shown in Figure 7.

PA transistors Q4 and Q5 operate as complementary emitter-followers, providing a 500 milliwatt output into an 8-ohm load. Audio from Pin 9 is coupled through capacitor C302 on the receiver boad to the loadspeaker.

SQUELCH A312

Noise from Audio Amplfier A310 operates the squelch circuit. A typical squelch circuit is shown in Figure 8.

When no carrier is present in the receiver, the noise output of active high-pass filter Ql is coupled to the base of noise amplifier Q2 through SQUELCH control R708. R708 controls the gain of the noise amplifier.

The output of noise amplifier Q2 is detected by diodes CR1 and CR2, and the resultant positive voltage turns off the PNP squelch switch Q3. In standard radios, the emitter of Q3 is connected to +7 volts by means of a jumper from H1 to H2. When noise turns off Q3, its collector drops to ground potential. As the collector of Q3 is connected to the base of amplifier Q1 in the Audio PA module, turning off Q3 also turns off Q1, keeping the audio PA turned off.

When the receiver is quieted by a signal, squelch switch Q3 turns on. This applies +7 volts to the base of amplifier Q1 in the Audio PA module, turning the Audio PA circuit on so that sound is heard at the speaker.

In tone decoder applications, the 7-volt jumper from H1 to H2 is removed. The emitter of squelch switch Q3 is connected to 7.5 volts by a DC switch on the decoder board.

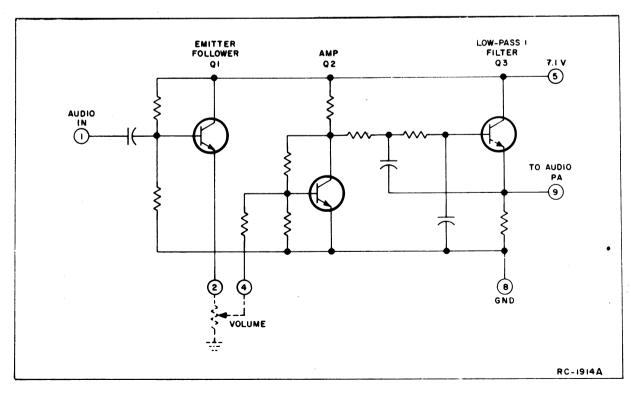


Figure 6 - Typical Audio Amplifier Circuit

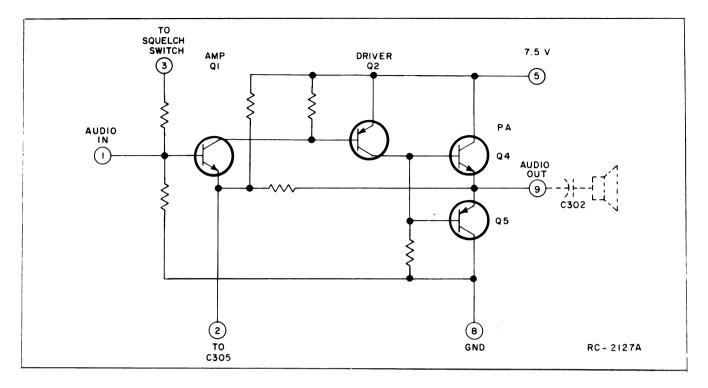


Figure 7 - Typical Audio PA Circuit

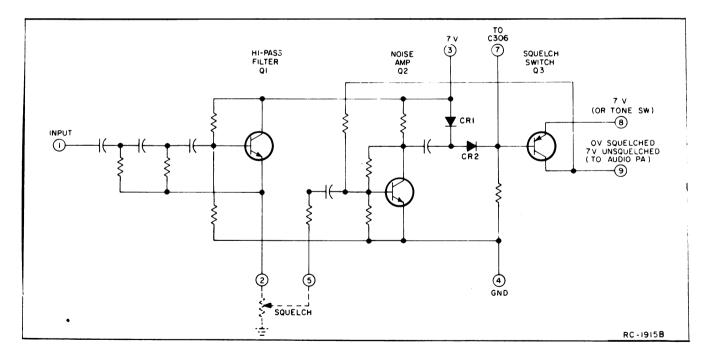
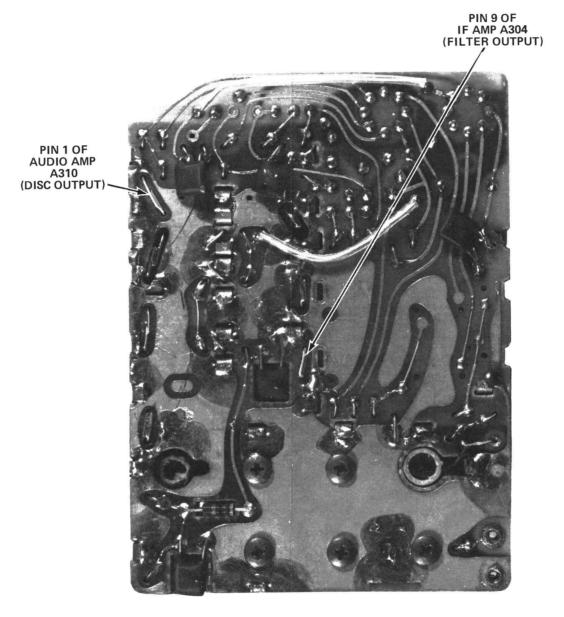


Figure 8 - Typical Squelch Circuit

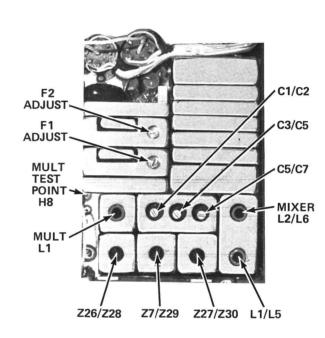
GENERAL ELECTRIC COMPANY • MOBILE COMMUNICATIONS DIVISION WORLD HEADQUARTERS • LYNCHBURG, VIRGINIA 24502 U.S.A.



SOLDER SIDE



COMPONENT SIDE



3

RECEIVER ALIGNMENT

EQUIPMENT

- 1. A 150.8-174 MHz source connected to antenna switch J702 by receiver test cable 19C317633G1.
- 2. GE Test Amplifier Model 4EX16AlO and RF probe 19C31l37OGl, or equivalent RF voltmeter.
- 3. Tektronic Oscilloscope Model No. 515A or equivalent.

PRELIMINARY ADJUSTMENTS

- Set tuning slug in mutliplier coil Ll at the top of the can for frequencies at the low end of the range, middle of the can for frequencies in the middle of the range and at the bottom of the can for frequencies at the high end of the range.
- Set helical resonators Z26/Z28, Z7/Z29 and Z27/Z30 at the top of the can for frequencies at the high end of the range and at the bottom of the can for frequencies at the low end of the range.
- 3. Connect the 150.8-174 MHz source to the antenna jack with 50 millivolts output.

RECEIVER ALIGNMENT

Step No.	Tuning Control	Procedure					
1.	Z26, Z7 & Z27, Z26/Z28, Z7/Z29, & Z27/Z30	With an on frequency signal applied to the antenna jack, tune helicals $\rm Z26/Z28$, $\rm Z7/Z29$ and $\rm Z27/Z30$ for maximum quieting sensitivity.					
2.	Mixer Ll/L5	Tune L1/L5 for maximum quieting sensitivity.					
3.	Filter C1/C2, C3/C5 & C5/C7	Tune C1/C2, C3/C5 & C5/C7 for maximum quieting sensitivity.					
4.	Mult. Ll	Tune L1 for maximum quieting sensitivity.					
5.	Mixer L2/L6	Modulate the 20 kHz signal generator with the sawtooth output of the oscilloscope. Set the sweep rate for 2 ms/cm. Connect the output of the detector probe to the vertical input of the scope. Set the vertical sensitivity of the scope for highest sensitivity. With the probe connected to pin 9 of A304 increase the input of the generator until the IF band pass is displayed on the scope. Adjust L2/L6 for maximum flatness. NOTE: The mixer will tune with the slug in two positions. The correct position is the one closest to the board.					
		FREQUENCY ADJUSTMENT					
6.	F1 Adjust F2 Adjust	While applying an on-frequency signal to J702, loosely couple a 20-MHz signal to the Mixer. Adjust the oscillator trimmer(s) for a zero beat frequency between the two signals.					
		Alternate Method: Apply a strong 20 MHz signal to the Mixer. Measure the output of the Discriminator with a DC-VTVM at Pin 1 of A310. Note the reading. Next, remove the 20-MHz signal and apply a strong on-frequency signal to J702. Then tune the oscillator trimmer(s) for the meter reading obtained at Pin 1 of A310.					

ALIGNMENT PROCEDURE

150.8—174 MHZ RECEIVER MODELS 4ER59C11 & 13

Issue 3

7

TEST PROCEDURES

These Test Procedures are designed to help you service a receiver that is operating --- but not properly. The problems encountered could be low power, poor sensitivity, distortion, and low gain. By following the sequence of test steps starting with Step 1, the defect can be quickly localized, Once the defective stage is pin-pointed, refer to the "Service Check" listed to correct

TEST EQUIPMENT REQUIRED

• Distortion Analyzer similar to: Heath IM-12

- Signal Generator similar to: Measurements M-800
- 6-dB attenuation pad
- Test Adaptor Model 4EX12A10

• RF Adaptor Cable 19C317633G1 • Test Connector 19B227389G1 • Test Cable 19C327327G1 DISTORTION ANALYZER SIGNAL GENERATOR LEVEL CHANNEL FREQUENCY RANGE CONTROL (SET LEVEL & DISTORTION RANGE) RF ADAPTOR CABLE DEVIATION

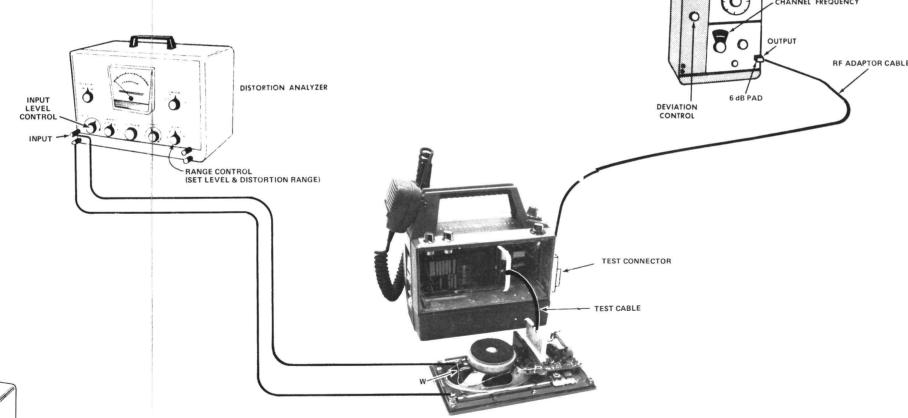
PE UNIT

the problem. Additional corrective measures are included in the Troubleshooting Procedure. Before starting with the Receiver Test Procedures, be sure the receiver is tuned and aligned to the proper operating frequency. To check Dual Front End receivers set multifrequency switch as follows:

FE#1 Multi-Freq. Switch to F1 or F2 FE#2 Multi-Freq. Switch to F3X

PRELIMINARY ADJUSTMENTS

- 1. Connect the test equipment to the receiver as shown for all steps of the receiver Test Procedure.
- 2. Turn the SQUELCH control fully clockwise for all steps of the Test Procedure.
- 3. Turn on all of the equipment and let it warm up for 20 minutes.



To keep from listening to 10 watts of

audio, an 8 ohm resistor, rated at more

the resistor is used, the white lead is

disconnected from the speaker terminal.

than 10 watts, may be connected between the

SIGNAL GENERATOR

white and blue leads on the speaker. When

NOTE:

Porta-Mobile II

STEP 1

AUDIO POWER OUTPUT AND DISTORTION TEST PROCEDURE

Measure Audio Power output as follows:

- A. Connect a 1,000-microvolt test signal modulated by 1.000 hertz ±3.0 kHz deviation to the Antenna Switch J702.
- B. Set the Volume Control for a 500 milliwatt output (2 volts RMS).
- C. Make distortion measurements according to manufacturer's instructions. Reading should be less than 10% (5% is typical). If the receiver sensitivity is to be measured, leave all controls and equipment as they are.

SERVICE CHECK

If the distortion is more than 5%, or maximum audio output is less than 0.5 watt, make the following checks:

- D. Battery voltage --- low voltage will cause distortion. (Refer to Receiver Schematic Diagram for voltages.)
- E. Audio Gain (Refer to Receiver Troubleshooting Procedure).

STEP 2

USABLE SENSITIVITY (12 dB SINAD) TEST PROCEDURE

If STEP 1 checks out properly, measure the receiver sensitivity as follows:

- A. Apply a 1000-microvolt, on-frequency signal modulated by 1000 Hz with 3.0 kHz deviation to J702.
- B. Place the RANGE switch on the Distortion Analyzer in the 200 to 2000-Hz distortion range position (1000-Hz filter in the circuit). Tune the filter for minimum reading or null on the lowest possible scale (100%, 30%, etc.)
- C. Place the RANGE switch to the SET LEVEL position (filter out of the circuit) and adjust the input LEVEL control for a +2 dB reading on a mid range (30%).
- D. While reducing the signal generator output, switch the RANGE control from SET LEVEL to the distortion range until a 12-dB difference (+2 dB to -10 dB) is obtained between the SET LEVEL and distortion range positions (filter out and filter in).

- E. The 12-dB difference (Signal plus Noise and Distortion to noise plus distortion ratio) is the "usable" sensitivity level. The sensitivity should be less than rated 12 dB SINAD specification with an audio output of at least 250 milliwatts.
- F. Leave all controls as they are and all equipment connected if the Modulation Acceptance Bandwidth test is to be per-

SERVICE CHECK

If the sensitivity level is more than rated 12 dB SINAD, check the alignment of the RF stages as directed in the Alignment Procedure, and make the gain measurements as shown on the Troubleshooting Procedure.

STEP 3

MODULATION ACCEPTANCE BANDWIDTH (IF BANDWIDTH)

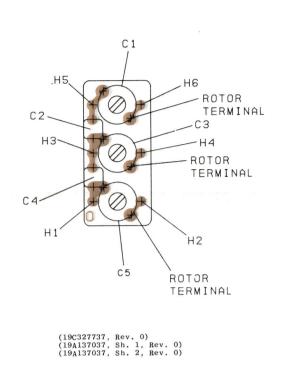
TEST PROCEDURE

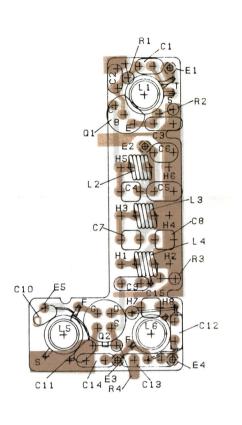
If STEPS 1 and 2 check out properly measure the bandwidth as follows:

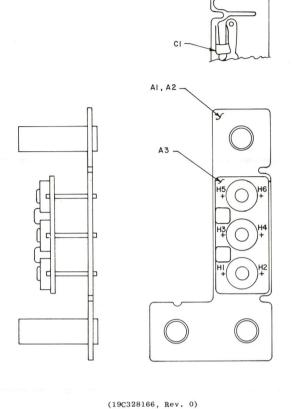
- A. Set the Signal Generator output for twice the microvolt reading obtained in the 12-dB SINAD measurement.
- B. Set the RANGE control on the Distortion Analyzer in the SET LEVEL position (1000-Hz filter out of the circuit), and adjust the input LEVEL control for a +2 dB reading on the 30% range.
- C. While increasing the deviation of the Signal Generator, switch the RANGE control from SET LEVEL to distortion range until a 12-dB difference is obtained between the SET LEVEL and distortion range readings (from +2 dB to -10 dB).
- D. The deviation control reading for the 12-dB difference is the Modulation Acceptance Bandwidth of the receiver. It should be more than ±7 kHz (but less than ±9 kHz).

SERVICE CHECK

If the Modulation Acceptance Bandwidth test does not indicate the proper width, make gain measurements as shown on the Receiver Troubleshooting Procedure.



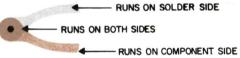


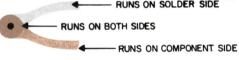


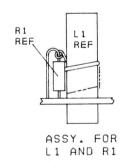
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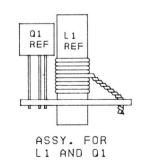
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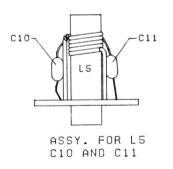
- RUNS ON SOLDER SIDE RUNS ON BOTH SIDES

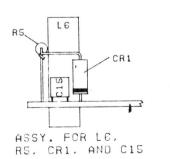


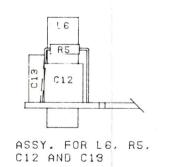


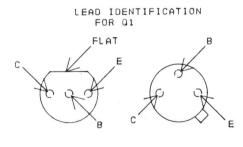












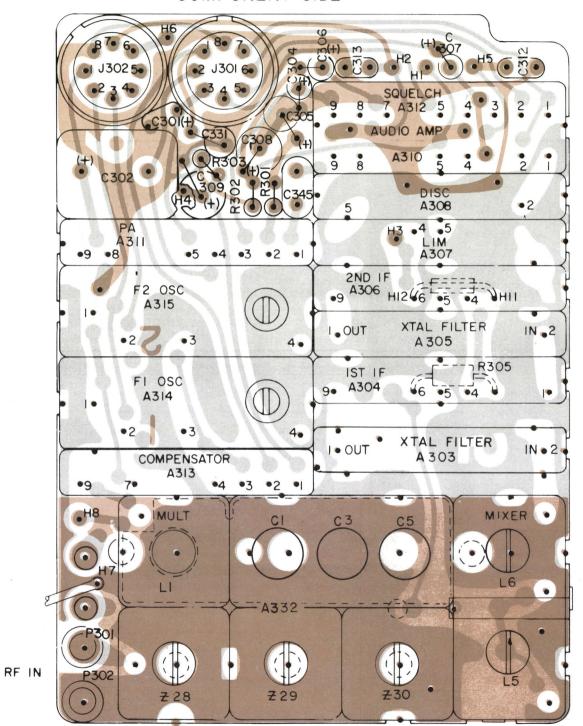
IN-LINE TRIANGULAR TOP VIEW NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.

OUTLINE DIAGRAM

150.8--174 MHz RECEIVER FRONT END (A332)

	PIN	PIN 2	PIN 3	PIN 4	PIN 5	PIN 6	PIN 7	PIN 8
J30I	5.4V	AUDIO OUT	SWITCHED 7.5V	SQ AR M	VOL ARM	SQ HI	VOL H1	GND
J302		FREQ I	FREQ 2			7.5 V	TONE SWITCH	GND

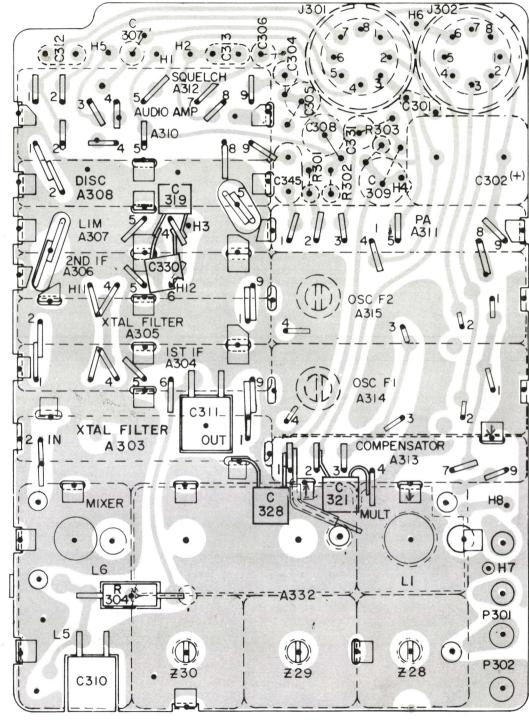
COMPONENT SIDE



OUTLINE DIAGRAM

150.8—174 MHz RECEIVER MODELS 4ER59C11 & 13

SOLDER SIDE



(19D416852, Sh. 2, Rev. 5)

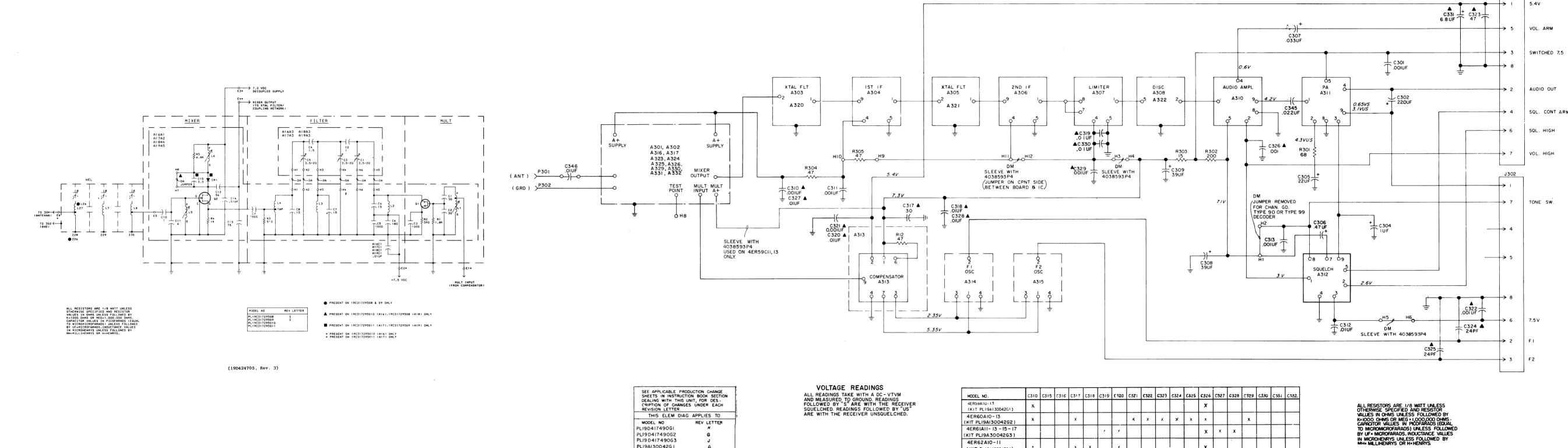
(19D416852, Sh. 2, Rev. 5) (19D416852, Sh. 3, Rev. 6)

(19D429259, Rev. 0)

RUNS ON SOLDER SIDE

- RUNS ON COMPONENT SIDE

- RUNS ON BOTH SIDES



A PART OF MODIFICATION KIT PLI9AI30042 SEE CHART BELOW FOR SELECTION OF PROPER PARTS FOR APPLICABLE MODEL NO.

PL19A130042G

PL19A130042G2 PLI9A130042G3 PLI9A130042G4 PLI9A130042G5 PLI9A130042G6

SCHEMATIC DIAGRAM

150.8—174 MHz RECEIVER FRONT END (A332)

(19R622035, Rev. 19)

(KIT PL19A130042G4)

(KIT PL19A130042G5) 4ER87A10-13

(KIT PLI9A130042G6

4ER59C11,13

IN ORDER TO RETAIN RATED EQUIPMENT PER-FORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COM-PONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

SCHEMATIC DIAGRAM

150.8—174 MHZ RECEIVER MODELS 4ER59C11 & 13

Issue 5

11

LBI-30000

PARTS LIST

LBI 30034D

150.8-174 MHz RECEIVER MODEL 4ER59C11 STANDARD MODEL 4ER59C13 CHANNEL GUARD

SYMBOL	GE PART NO.	DESCRIPTION
A329, A332		RECEIVER FRONT END A329 19C317295G8 REV E & LATER A332 19C217295G10
A12*		MIXER 19C321472G1 (Deleted by REV E)
Cl*	19A116114P2020	CAPACITORS
	19A116114P2142	Ceramic: 24 pf ±5%, 100 VDCW; temp coef -80 PPM.
C2*	5495323Pl2	Ceramic: 0.001 µf +100% -10%, 75 VDCW. Deleted by REV B.
C3*	19A116114P10073	Ceramic: 180 pf ±10%, 100 VDCW; temp coef -3300 PPM. Deleted by REV B.
C4	19A116114P3056	Ceramic: 56 pf ±5%, 100 VDCW; temp coef -150 PPM.
C5	19A116114P2060	Ceramic: 75 pf ±5%, 100 VDCW; temp coef -80 PPM.
C6	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.
C8	19A116114P1	Ceramic: 1 pf ±10%, 100 VDCW; temp coef 0 PPM.
Ll	19B226750G1	Coil. Includes:
	19B209436P1	Tuning slug.
L2	19C320379G11	Coil. Includes:
	19B209436P1	Tuning slug.
		TRANSISTORS
Q1	19All6960Pl	N Type, field effect; sim to Type 2N4416.
		RESISTORS
R1	3R151P682J	Composition: 6.8K ohms ±5%, 1/8 w.
R2	3R151P102J	Composition: 1K ohms ±5%, 1/8 w.
A13*		MULTIPLIER BOARD 19C32144OG1 (Deleted by REV E)
C1*	19A116114P2045	Ceramic: 30 pf ±5%, 100 VDCW; temp coef -80 PPM.
		In REV B & earlier:
	19A116114P2,044	Ceramic: 27 pf ±5%, 100 VDCW; temp coef -80 PPM.
C2*	19A116114P2045	Ceramic: 30 pf ±5%, 100 VDCW; temp coef -80 PPM. In REV A & B:
	19A116114P2044	Ceramic: 27 pf ±5%, 100 VDCW; temp coef -80 PPM.
		Earlier than REV A:
	19A116114P2041	Ceramic: 22 pf ±5%, 100 VDCW; temp coef -80 PPM.
C3*	19A116192P13	Ceramic: 1000 pf ±10%, 50 VDCW; sim to Erie 8121-A050-W5R-102K.
	19A116114P10073	Earlier than REV A: Ceramic: 180 pf ±10%, 100 VDCW; temp coef -3300 PPM.
Ll	19B226718G1	Coil. Includes:
	19B209436P1	Tuning slug.

	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
	Q1	19A115910P1	TRANSISTORS	27*		HELICAL RESONATORS Consists of L7 and 19D413132P3 can. Deleted by	J301	19A116122P1	JACKS AND RECEPTACLES Feed-thru: sim to Warren Co 1-B-2994-4.
			RESISTORS	Z26		REV E. Consists of L26 & 19C327717G1 can.	and J302	. 4	
ا ٦	R1*	3R151P182J	Composition: 1.8K ohms ±5%, 1/8 w. Earlier than REV A:	Z27* Z28		Consists of L8 & 19D413132P37 can. Deleted by REV E. Consists of L27 & 19C327717G1 can.	P301 and P302	19A115834P4	Contact, electrical: sim to AMP 2-332070-9.
$\ \cdot \ $	R2	3R151P103J 3R151P391K	Composition: 10K ohms ±5%, 1/8 w. Composition: 390 ohms ±10%, 1/8 w.	Z29* Z30*		Consists of L7 & 19C327717G1 can. Added by REV E. Consists of L8 & 19C327717G1 can. Added by REV E.	R301*	3R151P680J	
	A14*		FILTER BOARD 19C321453G1 (Deleted by REV E)	230*		RECEIVER BOARD 19041749061		3R151P101J	In REV D & earlier: Composition: 100 ohms ±5%, 1/8 w.
	C1	19A116114P3036		A303*	19C304824G1	Crystal Filter.	R302 R303	3R151P201J 3R151P150J	Composition: 200 ohms ±5%, 1/8 w. Composition: 15 ohms ±5%, 1/8 w.
	C2	19A134162P3	Variable, ceramic: approx 3.5 to 20 pf; sim to Erie Style 513-000.		19C304516G3	In REV C & earlier: Crystal Filter.	R304 and R305	3R151P470J	Composition: 47 ohms ±5%, 1/8 w.
	C3 C4	19A116114P1 19A116114P3036	Ceramic: 1 pf ±10%, 100 VDCW; temp coef 0 PPM. Ceramic: 15 pf ±5%, 100 VDCW; temp coef -80 PPM.	A304	19C311879G3	lst IF Amplifier.			RECEIVER KIT 19A130042G5
	C5 C6	19A134162P3 19A116114P3036	Variable, ceramic: approx 3.5 to 20 pf; sim to Erie Style 513-000. Ceramic: 15 pf ±5%, 100 VDCW; temp coef -150 PPM.	A305 A306	19C304824G1 19C311879G4	Crystal Filter. 2nd IF Amplifier.	C310	5495323P12	
	C7	19A134162P3	Variable, ceramic: approx 3.5 to 20 pf; sim to Erie Style 513-000.	A307	19C311876G4	Limiter.	C319	19Al16192P1	Ceramic: 0.01 µf ±20%, 50 YDCW; sim to Erie 8121 SPECIAL.
	C9	19A116114P4 19A116114P10073	Ceramic: 1.5 pf ±5%, 100 VDCW; temp coef 0 PPM. Ceramic: 180 pf ±10%, 100 VDCW; temp coef -3300 PPM.	A308 A309*	19C304504G3	Discriminator. Audio Amplifier. Deleted by REV H.	C321 C326*	5495323P12 5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW. Ceramic: .001 µf +100% -20%, 75 VDCW. Added by REV A.
	C10	19A116192P13 5495323P12	Ceramic: 1000 pf ±10%, 50 VDCW; sim to Erie 8121-A050-W5R-102K. Ceramic: .001 µf +100% -20%, 75 VDCW. Added by	A310*	19C330341G1	Audio Amplifier.	C328	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.
	011	0435525122	REV B.		19C311995G4	In REV H & earlier: Audio Amplifier. (Includes Tone Filter).	C330	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.
				A311*	19C311877G4	PA.	C331	5491674P39	Tantalum: 6.8 µf ±20%,15 VDCW; sim to Sprague Type 162D.
	L1 and L2	19A130474P1	Coil.		19C311877G2	In REV F & earlier:	C332*	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie 8121 SPECIAL. Deleted by REV B.
	L3	19A130473P1	Coil.	A312*	19C330342G1	Squelch. In REV H & earlier:		19B216316P1	MISCELLANEOUS Insulator, (Used with J301 and J302).
	R1*	3R151P511J	Composition: 510 ohms ±5%, 1/8 w. Added by REV C. MULTIPLIER-MIXER		19C311880G4	Squelch.		19A127737P1 19B219801P2	Spring. (Solders to Al2 can). Shield. (Used with Z26).
	A18		A16 19C327738G1 A18 19C327738G3	A313	19C320061G1	Compensator.			oscillators
	A1 A3	19D424746G1 19C327735G1	Multiplier-Mixer Module. Multiplier-Mixer Module.	C301 C302	5495323P12 19A116178P7	Ceramic: .001 µf +100% -20%, 75 VDCW. Tantalum: 220 µf ±20%, 6 VDCW.	A314		OSCILLATOR MODULES USED IN PE APPLICATIONS NOTE: When reordering, give GE Part Number &
	A4	19D424746G3	Multiplier-Mixer Module.	C303*	19A116089P1	Ceramic: 0.1 μ f $\pm 20\%$, 50 VDCW, temp range -55 to +85°C. Deleted by REV H.	and A315	4EG28A11	specify exact frequency needed. Oscillator Module. 150.8-174 MHz. Fx = Fo - 20
	C1	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.	C304	5491674P28 5491674P35	Tantalum: 1.0 µf ±20%, 25 VDCW; sim to Sprague Type 162D. Tantalum: 22 µf ±20%, 4 VDCW; sim to Sprague	A314,		OSCILLATOR MODULES USED IN PORTA MOBILE II APPLICATIONS NOTE: When reordering, give GE Part Number &
	L7	19B216441G3		C306	5491674P27	Type 162D. Tantalum: .47 µf ±20%, 35 VDCW; sim to Sprague Type 162D.	A315, and A1 thru		specify exact frequency needed.
	L8	19C311727P1 19B216441G12	Tuning slug. Helical resonator. (Part of Z30). Includes:	C307	5491674P31 5491674P30	Tantalum: .033 µf ±20%, 35 VDCW; sim to Sprague Type 162D. Tantalum: 39 µf ±20%, 10 VDCW; sim to Sprague	A10	4EG38A14	Oscillator Module. 150.8-174 MHz. $Fx = \frac{Fo - 20}{9}$
	L26	19C311727P1 19B216441G16	Tuning slug. Helical resonator. (Part of Z26). Includes:	and C309	5495323P12	Type 162D. Ceramic: .001 µf +100% -20%, 75 VDCW.			
	L27	19C311727Pl 19B216441G17	Tuning slug. Helical resonator. (Part of Z28). Includes:	C312	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie 8121 SPECIAL.			
		19C311727P1	Tuning slug.	C313	5495323P12 5495323P12	Ceramic: .001 µf +100% -20%, 75 VDCW. Ceramic: .001 µf +100% -20%, 75 VDCW. Deleted by REV E.			
				C345*	19A116192P6	Ceramic: 0.022 µf ±20%, 50 VDCW; sim to Erie 8131-M050-W5R-223M. Added by REV F.			
				C346*	19A116192P1	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie 8121 SPECIAL. Added by REV K.			

12 *COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts effected by these revisions.

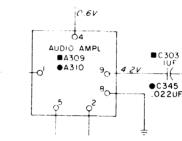
PRODUCTION CHANGES

REV. A - Receiver Board 19D417490G1

To increase audio sensitivity. Changed R301.

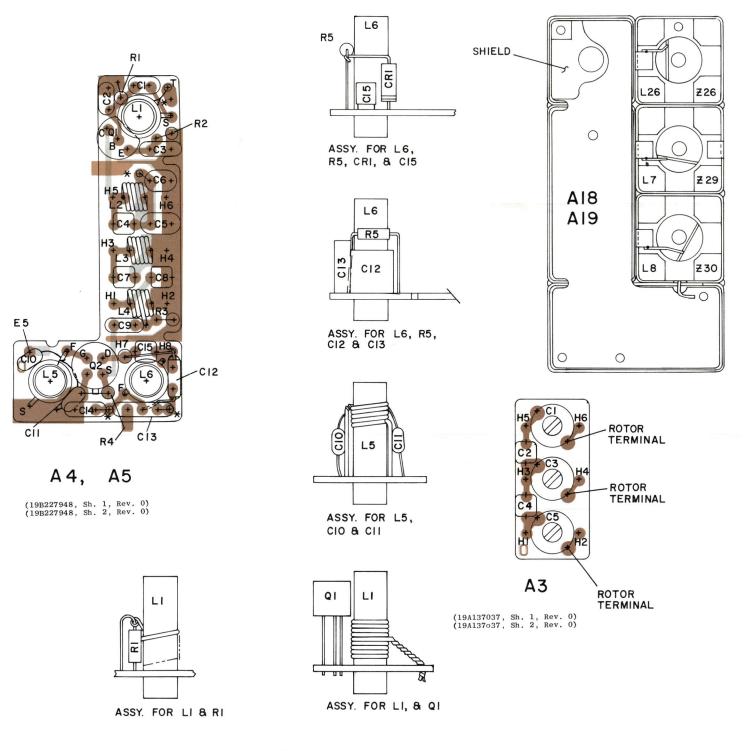
- REV. B To improve squelch action. Changed C312.
- REV. C To improve operation. Changed A313.
- REV. D To improve producibility. Changed A303.
- REV. E To improve audio stability.
 Deleted C314 and changed R301.
- REV. F To improve audio frequency response.
 Added C345 to be used with CG receivers.
- REV. G Receiver Board 19D417490G1
- To improve audic quality. Changed A311.
- REV. H To eliminate Non-Channel Guard receiver boards.
 Deleted callout of ■A309 and circle (●) in
 front of A310. Deleted callout of ■C303 and
 the circle (●) for C345. Deleted Notes:
 ■Use for Non-Channel Guard receivers and use
 for Channel Guard receivers.

Schematic Diagram Was:

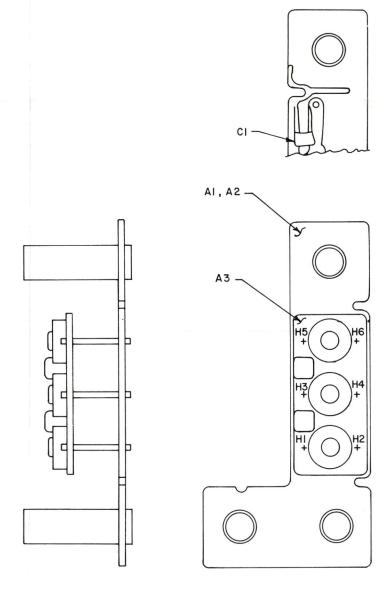


REV. A - Receiver Kit 19A130042G5

- To improve IF filtering. Added C326.
- REV. B To standardize assemblies. Deleted C332.
- REV. E Receiver Front End 19C317295G8
 - To build receiver front end 19C317295G8 for Service Parts with the same material used to build receiver front end 19C317295G10.

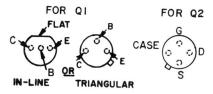


(19D423645, Rev. 3)



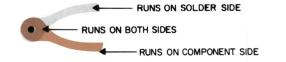
(19C328166, Rev. 0)

LEAD IDENTIFICATION



TOP VIEW

NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION.



OUTLINE DIAGRAM

150.8--174 MHZ RECEIVER FRONT END (A329) REVISION E AND LATER

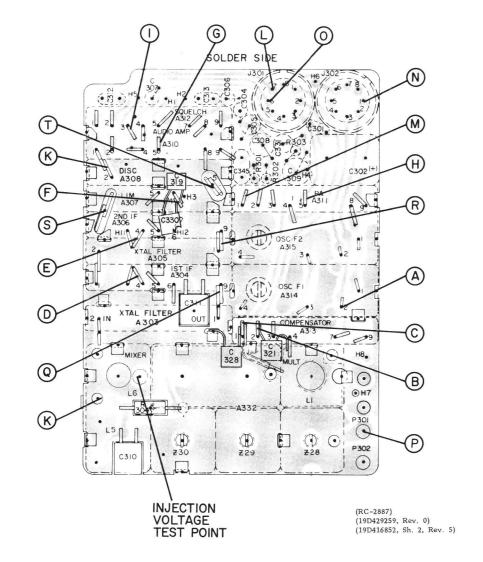
0.6 MA SQUELCHED

A311

7 V 0.5 MA

QUICK CHECKS

SYMPTOM	PROCEDURE					
No Audio	1. Check audio waveform at the top of the Volume Control (see Step 2).					
	If audio is present, check voltage readings of Audio and Squelch modules (see Schematic Diagram).					
	3. If audio is not present, check gain and current readings of Front End and IF modules (see Steps 1 & 3).					
Poor Sensi- tivity	1. Measure the injection voltage for a min- imum level of 750 millivolts. If the reading is low, check the output of the Oscillator and Compensator modules with an RF voltmeter.					
	Measure the gain of the Mixer stage (see Step 3). If low, measure the gain of the RF amplifier and IF modules.					
Improper Squelch Operation	Check the noise waveform at the input to the Squelch module and at Squelch Control high (see Step 2).					
	Measure the DC voltages for the Squelch module (squelched and unsquelched).					



STEP 3 - RF GAIN CHECKS

EQUIPMENT REQUIRED:

- RF probe and Test Amplifier Model 4EX16A10 connected to GE Test Set Model 4EX3A10, or an RF voltmeter.
- A signal generator (M-800 or equivalent) connected to P301 (High) and P302 (Low).

PROCEDURE FOR MIXER & 1ST IF:

- 1. Switch the Test Set to the Test 1 position and the Test Amplifier to the ${\tt X50}$ position.
- Connect the RF probe across the input of the stage to be measured as shown on the diagram. Increase the signal generator output to obtain a reference reading on Test Set 4EX3AlO. Note the Test Set reading and the dB reading on the generator (dBl).
- Connect the RF probe to the output of the stage to be measured as shown on the diagram. Decrease the generator output until the Test Set reference reading in Step 2 is obtained. Note the dB reading on the generator (dB2).
- Subtract the dBl reading from the dB2 reading and check the results with the typical gains shown on the diagram.

PROCEDURE FOR 2ND IF:

- With no signal in, connect the RF probe to the output of the 2nd IF module. Increase the signal generator output until the Test Set reading increases by approximately 0.2 volt. Note Test Set and signal generator reading (dB2).
- Connect the probe to the input of the 2nd IF module. Increase the signal generator until the Test Set reference reading is obtained, and note the dB reading (dB1).
- 3. Now subtract dB2 from dBl to obtain the gain of the 2nd IF amplifier module.

LIMITER CHECK

The Limiter module limits on noise so the gain of the circuit cannot be measured. The following procedure provides a check to determine if the module is limiting

- Switch the Test Amplifier to the Xl position and the Test Set to the Test l position. Then connect the RF probe to the output of the Limiter module and check for a reading of approximately 0.4 volt.

STEP 1MODULE CURRENT CHECKS. STEP 1MODULE CURRENT CHECKS. These current readings provide a method of checking the operation of each integrated Circuit module using a milliam-mater (Triplett 630 or equivalent). MIXER A12/A15 INJECTION FILTER A14 A313 © OSC A314/A315 A313 OSC A314/A315 A314 A315 OSC A314/A315 A314 A315 OSC A314/A315 A315 OSC A314/A315 A314 A315 OSC A314/A315 A315 OSC A314/A315 A316 A314 A315 OSC A314/A315 A314 A315 A315 A314 A315 A314 A315 A

1. Unsolder the + lead as shown in the Diagram of the module

When checking the current of Audio PA module A311, do not short Pin 4 to ground or to + (Pin 5). To

do so will destroy the Audio PA module.

Connect the milliammeter in series with the + lead, and check for the indicated current drain and supply voltage. No current drain indicates that the module should be

AUDIO & SQUELCH WAVEFORMS (STEPS K THRU 0)

EQUIPMENT REQUIRED:

STEP 2 -

- Oscilloscope connected between the points shown and ground.
- Signal Generator (Measurements M-800 or equivalent).

PRELIMINARY STEPS:

- Apply a standard signal to P301. A standard signal is 1000 microvolts on the receiver frequency modulated by one kHz with 3.0 -kHz deviation.
- 2. Set the Volume control for 0.5-watt output.

PEAK-TO-PEAK SIGNAL 0.35 V 0.25 V 5.6 V READINGS NÖISE 0.9 V 0.9 V 0.25 V 5.6 V 0.7 V 0.7 V 0.9 V 0.25 V 0.25 V 0.7 V 0.

VOLUME |

LIMITER A307

TROUBLESHOOTING PROCEDURE

150.8—174 MHZ RECEIVER MODELS 4ER59C11 & 13

PARTS LIST

LBI30608A

19C317295G8 - REV D & EARLIER

	19C317295G8 - REV D & EARLIER (Replaced by 19C317295G10)				3R151P103J	Earlier than REV A: Composition: 10K ohms $\pm 5\%$, 1/8 w.
ĺ					3R151P391K	Composition: 390 ohms ±10%, 1/8 w.
	SYMBOL GE PART NO. DESCRIPTION		A14		FILTER BOARD 19C321453G1	
	A12		MIXER 19C321472G1		10411611470006	
				C1 C2	19A116114P3036 19A134162P3	Ceramic: 15 pf ±5%, 100 VDCW; temp coef -150 PPM. Variable, ceramic: approx 3.5 to 20 pf; sim to
)	C1*	19A116114P2020	Ceramic: 6 pf ±5%, 100 VDCW; temp coef -80 PPM.	02	10,110,110	Erie Style 513-001.
			In REV A and earlier:	C3	19A116114P1	Ceramic: 1 pf ±10%, 100 VDCW; temp coef 0 PPM.
CTION CHANGE		19All6ll4P2l42	Ceramic: 24 pf ±5%, 100 VDCW; temp coef -80 PPM.	C4	19A116114P3036	Ceramic: 15 pf ±5%, 100 VDCW; temp coef -80 PPM.
BOOK SECTION T, FOR DES - UNDER EACH	C2*	5495323P12	Ceramic: 0.001 μ f +100% -10%, 75 VDCW. Deleted by REV B.	C5	19A134162P3	Variable, ceramic: approx 3.5 to 20 pf; sim to Erie Style 513-001.
APPLIES TO	C3*	19A116114P10073	Ceramic: 180 pf ±10%, 100 VDCW; temp coef -3300 PPM. Deleted by REV B.	C6 C7	19A116114P3036 19A134162P3	Ceramic: 15 pf ±5%, 100 VDCW; temp coef -150 PPM. Variable, ceramic: approx 3.5 to 20 pf; sim to
REV LETTER D	C4	19A116114P3056	Ceramic: 56 pf ±5%, 100 VDCW; temp coef -150 PPM.			Erie Style 513-001.
D !	C5	19A116114P2060	Ceramic: 75 pf ±5%, 100 VDCW; temp coef -80 PPM.	C8	19A116114P4	Ceramic: 1.5 pf ±5%, 100 VDCW; temp coef 0 PPM.
	C6	19A116192P1	Ceramic: 0.01 μ f $\pm 20\%$, 50 VDCW; sim to Erie 8121 SPECIAL.	Ċ9	19A116114P10073	Ceramic: 180 pf ±10%, 100 VDCW; temp coef -3300 PPM.
j	C8	19All6ll4Pl	Ceramic: 1 pf ±10%, 100 VDCW; temp coef 0 PPM.	C10	. 5495323P12	Ceramic: 0.001 µf +100% -20%, 75 VDCW.
- ₁				C11*	5495323P12	Ceramic: 0.001 μf +100% -20%, 75 VDCW. Added by REV B.
				C12*	19Al16192Pl	Ceramic: 0.01 µf ±20%, 50 VDCW; sim to Erie
1	Ll	19B226750G1 19B209436P1	Coil. Includes: Tuning slug.			8121 SPECIAL. Added by REV D.
MULT INPUT	L2	19B209438P1 19C320379G11	Coil. Includes:			
(TO COMPENSATOR'	1,2	19B209436P1	Tuning slug.	L1 and	19A130474P1	Coil.
				L2		
1	0.1	10411505001	N Type, field effect; sim to Type 2N4416.	L3	19A130473P1	Coil.
	Q1	19A116960P1	N Type, field effect, Sim to Type 2N4410.			RESISTORS
•			RESISTORS	R1*	3R151P511J	Composition: 510 ohms $\pm 5\%$, $1/8$ w. Added by REV C.
	Rl	3R151P682J	Composition: 6.8K ohms ±5%, 1/8 w.			
	R2	3R151P102J	Composition: 1K ohms ±5%, 1/8 w.	L7	19B216441G3	
	A13		MULTIPLIER BOARD 19C321440G1	L .	19C311727P1	Tuning slug.
				L8	19B216441G12	Helical resonator. (Part of Z27). Includes:
					19C311727P1	Tuning slug.
	C1*	19A116114P2045	Ceramic: 30 pf ±5%, 100 VDCW; temp coef -80 PPM. In REV B and earlier:	L26	19B216441G16	Helical resonator. (Part of Z26). Includes:
		19A116114P2044	Ceramic: 27 pf ±5%, 100 VDCW; temp coef -80 PPM.		19C311727P1	Tuning slug.
	C2*	19A116114P2045	Ceramic: 30 pf ±5%, 100 VDCW; temp coef -80 PPM.			HELICAL RESONATORS
			In REV A and B:	27		Consists of L7 and 19D413132G3 can.
		19A116114P2044	Ceramic: 27 pf ±5%, 100 VDCW; temp coef -80 PPM.	Z26		Consists of L26 and 19D413132G36 can.
			Earlier than REV A:	Z27		Consists of L8 and 19D413132G37 can.
		19A116114P2041	Ceramic: 22 pf ±5%, 100 VDCW; temp coef -80 PPM.			
	C3*	19A116192P13	Ceramic: 1000 pf $\pm 10\%$, 50 VDCW; sim to Erie 8121-A050-W5R-102K.			
		19A116114P10073	Earlier than REV A: Ceramic: 180 pf ±10%, 100 VDCW; temp coef		7	
			-3300 PPM.			
	Ll	19B226718G1	Coil.			
	Q1	19A115910P1	Silicon, NPN; sim to Type 2N3904.			
				1		
	*COMPON	ENTS ADDED, DE	LETED OR CHANGED BY PRODUCTION CHANGES			

SYMBOL

Rl*

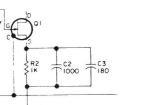
PRODUCTION CHANGES

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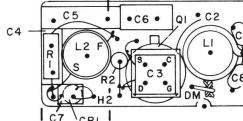
REV. A - Receiver Front End 19C317295G8 To improve sensitivity. Changed Cl on Al2/Al5. Changed C2 and C3 on Al4. Changed R1 on Al3.

REV. B - To improve tuning.
Deleted C2, C3 and changed R1 on
A12/A15 as shown.

Schematic Diagram was:



Outline Diagram was:



REV. D - To standardize assemblies and repackage H1 lM front

GE PART NO DESCRIPTION ----- RESISTORS -----3R151P182J Composition: 1.8K ohms ±5%, 1/8 w. ---coef -150 PPM 0 pf; sim to coef 0 PPM. coef -80 PPM o pf; sim to

> DCW. Added to Erie

> > REV. C - To improve tuning. Changed C1 and C2 on Al3. Added R1 to Al4. Changed design of L1 on Al2/Al5.

ends. Added Cl2.

Issue

CASE SHAPF, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION TAB INDICATES EMITTER LEAD.

_____MIXER _____ ____

(19C321481, Rev. 7)

+ 7 5 VDC

▲ PRESENT ON 19C317295G8 (A12) ONLY

■ PRESENT ON 19C317295G9 (AI5) ONLY

DECOUPLED SUPPLY

MIXER GUTPUT

COUPLING NETWORK!

SEE APPLICABLE PRODUCTION CHANGE SMEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DES-CRIPTION OF CHANGES UNDER EACH REVISION LETTER THIS ELEM DIAG APPLIES TO

REV LETTER

MULT INPUT

A12/A15

IN ORDER TO RETAIN RATED EQUIPMENT

PERFORMANCE. REPLACEMENT OF ANY

SERVICE PART SHOULD BE MADE ONLY WITH

A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART

ALL RESISTORS ARE 1/8 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR STALLES IN OHMS UNLESS FOLLOWED BY K-1000, OHMS OF MEG-1, 000,000 OHMS CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED IN THE PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED

BY UF = MICROFARADS, INDUCTANCE VALUES
IN MICROHENRYS UNLESS FOLLOWED BY
MH= MILLIHENRYS QR H=HENRYS